Support information

Title: Stoichiometry Dependence of Physical and Electrochemical Properties of the SnO_x Film Anodes Deposited by Pulse DC Magnetron Sputtering

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S1. Cross-section images and film thickness



Fig. S1 Cross–section SEM images and film thickness of the SnO_x films deposited at different Ar/O₂ flow ratios: (a) Ar/O₂=30/0, (b) Ar/O₂=29/1, (c) Ar/O₂=28/2, (d) Ar/O₂=26/4, (e) Ar/O₂=25/5, (f) Ar/O₂=24/6, (g) Ar/O₂=23/7

S2. Sn element distribution on the SnO_x film surface before cycling



Fig. S2 EDS mapping of the Sn element distribution of the SnO_x films deposited at different Ar/O₂ flow ratios: (a) Ar/O₂=30/0, (b) Ar/O₂=29/1, (c) Ar/O₂=28/2, (d) Ar/O₂=26/4, (e) Ar/O₂=25/5, (f) Ar/O₂=24/6, (g) Ar/O₂=23/7

S3. Sn and O element distribution on the SnO_x film surface after cycling

A BASSON	(a) $Ar/O_2 = 30/0$	
200 nm	200 nm	200 nm
	(b) Ar/O ₂ =29/1	
200 nm	<u>200</u> nm	200 nm
and the first	(c) $Ar/O_2 = 28/2$	
and the second second	A 00	200
200 nm	200 nm	200 nm
	(d) $Ar/O_2 = 26/4$	
Concelle !!		
200	200 nm	200 nm
200 1111 0	(e) $Ar/O_{2}=25/5$	200
R. L. C. L.	(C) AI/02-23/3	
A PAS		
200 nm	200 nm	200 nm
	(f) $Ar/O_2 = 24/6$	
Charles and the		
Month Ba		
<u>200 nm</u>	<u>200</u> nm	<u>200 nm</u>
March Con 1987	(g) $Ar/O_2 = 23/7$	
2011/16		
12/23		
<u>200 nm</u>	200 nm	200 nm

Fig. S3 The local morphology and corresponding EDS element distribution of SnO_x films deposited at Ar/O₂ flow ratio of (a) 30/0, (b) 29/1, (c) 28/2, (d) 26/4, (e) 25/5, (f) 24/6, (g) 23/7 after cycling 20 cycles

S4. AFM images



Fig. S4 AFM images of the SnO_x films deposited with different Ar/O₂ flow ratios

S5. XRR measurement principle and its fitting model

The measurement principle is that X-rays are incident obliquely into the film medium at a small incident angle, both refraction and reflection occur on the surface/ interface positions between the film and substrate. Two beams of light reflected on the upper and lower interfaces appear light interference, and periodic oscillation curve of reflection intensity is obtained when changing the incident angle. The fitting procedures are carried out by a complex function containing parameters of film thickness, surface roughness and density ^[1–3].



Fig. S5 XRR fitting model: layered film structure

S6. Summary of survey map in XPS



Fig. S6 Survey spectra of the SnO_x films deposited with different Ar/O₂ flow ratios



S7. Comparison of the XPS spectra after Ar⁺ etching

Fig. S7 The XPS spectra of two samples deposited with (a~c) Ar/O₂=30/0 and (d~f) Ar/O₂=23/7, the black line corresponds to the state before Ar⁺ etching, and the red line represents the state after Ar⁺ etching 100 s.

S8. The XPS spectra of SnO₂ standard material



Fig. S8 The XPS spectra of the SnO₂ power standard material.

S9. First charge and discharge curves of the SnO_x film electrodes



Fig. S9 1st discharge and 1st charge curves of the SnO_x films fabricated with different Ar/O₂ flow ratios, measured at a current density of 44 μA/cm², the charge and discharge cut-off voltage range is (0.01~1.2) V

References

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